

3.5x2.8 mm SMD CHIP LED LAMP

AA3528SRC

SUPER BRIGHT RED

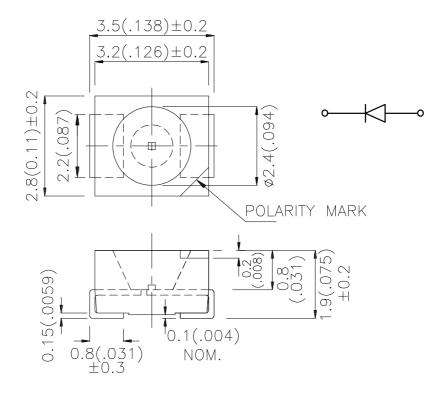
Features

- SINGLE COLOR.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- IDEAL FOR BACKLIGHTING.
- PACKAGE: 1500PCS / REEL.
- RoHS COMPLIANT.

Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

SPEC NO: DSAC4334 REV NO: V.6 DATE: MAR/21/2005 PAGE: 1 OF 4
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Selection Guide

Part No.	Dice	Lens Type	lv (n @ 2	,	Viewing Angle
			Min.	Тур.	2 θ 1/2
AA3528SRC	SUPER BRIGHT RED (GaAlAs)	WATER CLEAR	50	150	120°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Red	660		nm	IF=20mA
λD	Dominant Wavelength	Super Bright Red	640		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Red	20		nm	IF=20mA
С	Capacitance	Super Bright Red	45		pF	VF=0V;f=1MHz
VF	Forward Voltage	Super Bright Red	1.85	2.5	V	IF=20mA
IR	Reverse Current	Super Bright Red		10	uA	VR = 5V

Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Red	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	155	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note

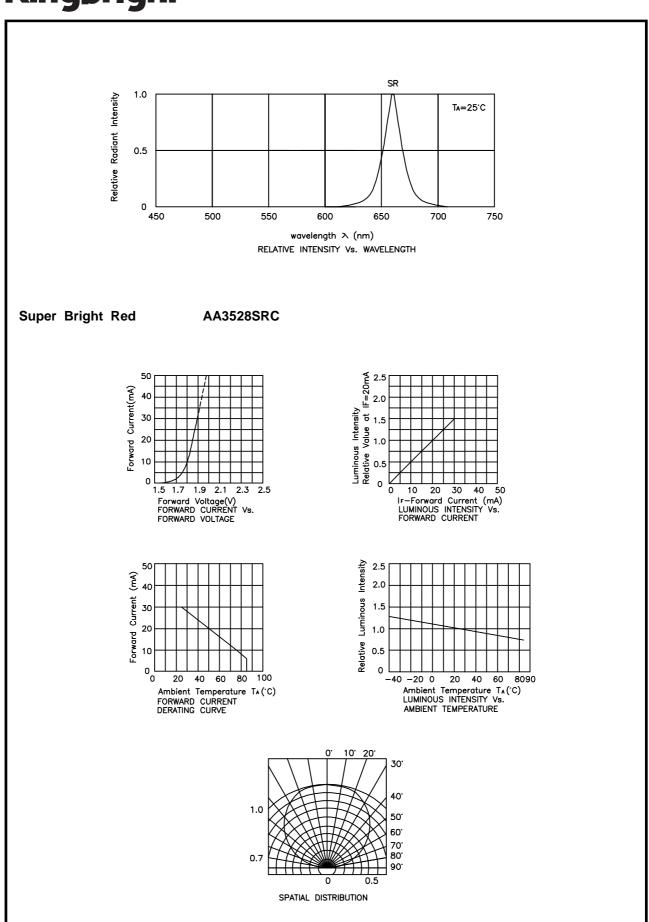
SPEC NO: DSAC4334 REV NO: V.6 DATE: MAR/21/2005 PAGE: 2 OF 4

APPROVED: J. Lu CHECKED: Allen Liu DRAWN: W.J.ZHU ERP:1201000381

^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

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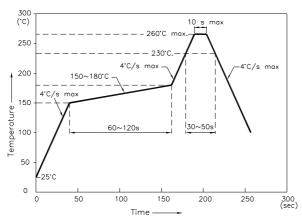
SPEC NO: DSAC4334 REV NO: V.6 DATE: MAR/21/2005 PAGE: 3 OF 4

APPROVED: J. Lu CHECKED: Allen Liu DRAWN: W.J.ZHU ERP:1201000381

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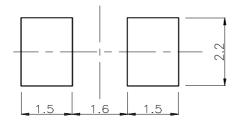
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Reflow Soldering Profile For Lead-free SMT Process.

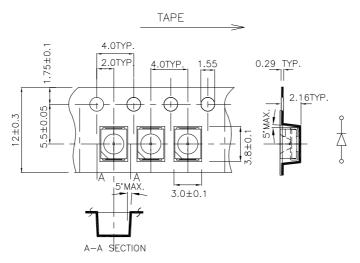


- NOTES: 1.We recommend the reflow temperature 245°C(\pm / \pm 5°C).The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



If special sorting is required (e.g. binning based on forward voltage,luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

SPEC NO: DSAC4334 **REV NO: V.6 DATE: MAR/21/2005** PAGE: 4 OF 4 APPROVED: J. Lu CHECKED: Allen Liu DRAWN: W.J.ZHU ERP:1201000381